TOSHIBA TCD2558D

**TENTATIVE** 

TOSHIBA CCD LINEAR IMAGE SENSOR CCD (Charge Coupled Device)

# T C D 2 5 5 8 D

The TCD2558D is a high sensitive and low dark current 5340 elements x 3 line CCD color image sensor which includes CCD drive circuit, clamp circuit.

The sensor can be used for image scanner. The device contains a row of  $5340 \times 3$  photodioeds, which provide a 24 lines/mm (600DPI) across a A4 size paper. The divice is operated by 5 V (Pulse), and 12 V power supply.

#### **FEATURES**

Number of Image Sensing Elements

: 5340 elements x 3 line

Image Sensing Element Size : 7  $\mu$ m by 7  $\mu$ m on 7  $\mu$ m centers

**Photo Sensing Region** : High sensitive and low dark

current PN photodiode

Distance Between Photodiode Array : 28  $\mu$ m, 4 line

: 2 phase (5 V)

**Power Supply** : 12 V Power supply voltage

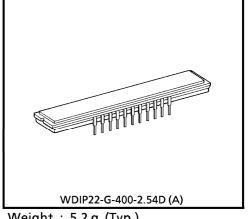
Internal Circuit : Clamp Circuit

**Package** : 22 pin CERDIP package Color Filter : Red, Green, Blue

## **MAXIMUM RATINGS** (Note 1)

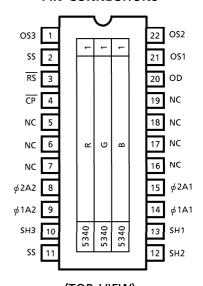
CHARACTERISTIC	SYMBOL	RATING	UNIT	
Clock Pulse Voltage	Vφ			
Shift Pulse Voltage	V <sub>SH</sub>	-0.3~8	l v	
Reset Pulse Voltage	VRS			
Clamp Pulse Voltage	VCP			
Power Supply	V <sub>OD</sub>	-0.3~15	V	
Operating Temperature	Topr	0~60	°C	
Storage Temperature	T <sub>stg</sub>	<b>- 25∼85</b>	°C	

(Note 1): All voltage are with respect to SS terminals (Ground).



Weight: 5.2 g (Typ.)

#### **PIN CONNECTIONS**

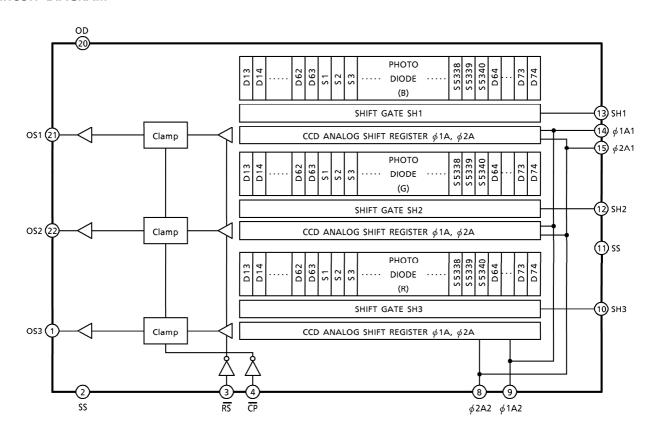


(TOP VIEW)

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## **CIRCUIT DIAGRAM**



### **PIN NAMES**

PIN No.	SYMBOL	NAME	PIN No.	SYMBOL	NAME
1	OS3	Signal Output 3 (Red)	12	SH2	Shift Gate 2
2	SS	Ground	13	SH1	Shift Gate 1
3	RS	Reset Gate	14	φ1A1	Clock 1 (Phase 1)
4	CP	Clamp Gate	15	φ2A1	Clock 1 (Phase 2)
5	NC	Non Connection	16	NC	Non Connection
6	NC	Non Connection	17	NC	Non Connection
7	NC	Non Connection	18	NC	Non Connection
8	φ2A2	Clock 2 (Phase 2)	19	NC	Non Connection
9	φ1A2	Clock 2 (Phase 1)	20	OD	Power
10	SH3	Shift Gate 3	21	OS1	Signal Output 1 (Blue)
11	SS	Ground	22	OS2	Signal Output 2 (Green)

#### **OPTICAL / ELECTRICAL CHARACTERISTICS**

(Ta = 25°C,  $V_{OD}$  = 12 V,  $V_{\phi}$  =  $V_{\overline{SH}}$  =  $V_{\overline{RS}}$  =  $V_{\overline{CP}}$  = 5 V (PULSE),  $f_{\phi}$  = 1 MHz,  $f_{\overline{RS}}$  = 1 MHz,  $t_{|NT}$  = 10 ms, LIGHT SOURCE = A LIGHT SOURCE + CM500S FILTER (t = 1 mm), LOAD RESISTANCE = 100 k $\Omega$ )

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE
	R <sub>R</sub>	6.5	9.3	12.1		
Sensitivity	RG	6.9	9.9	12.9	V / (lx·s)	(Note 2)
	R <sub>B</sub>	3.8	5.4	7.0		
Photo Borneys New Uniformity	PRNU (1)	<b>—</b>	10	20	%	(Note 3)
Photo Response Non Uniformity	PRNU (3)	_	3	12	mV	(Note 4)
Image Lag	IL	_	1	_	%	(Note 5)
Saturation Output Voltage	VSAT	3.2	3.5	_	V	(Note 6)
Saturation Exposure	SE	T —	0.35	_	lx∙s	(Note 7)
Dark Signal Voltage	V <sub>DRK</sub>	_	0.5	2.0	mV	(Note 8)
Dark Signal Non Uniformity	DSNU	_	5.0	9.0	mV	(Note 8)
DC Power Dissipation	PD	<u> </u>	430	600	mW	
Total Transfer Efficiency	TTE	92	_	_	%	
Output Impedance	ZO	<u> </u>	0.1	1.0	kΩ	
DC Signal Output Voltage	Vos	5	6	7	V	(Note 9)
Random Noise	N <sub>D</sub> σ	<u> </u>	0.8	_	mV	(Note 10)
Reset Noise	V <sub>RSN</sub>	_	0.5	1.0	V	(Note 9)

- (Note 2) : Responsivity is defined for each color of signal outputs average when the photosensitive surface is applied with the light of uniform illumination and uniform color temperature.
- (Note 3) : PRNU (1) is defined for each color on a single chip by the expressions below when the photosensitive surface is applied with the light of uniform illumination and uniform color temperature.

PRNU (1) = 
$$\frac{\Delta \chi}{\overline{\chi}}$$
 × 100 (%)

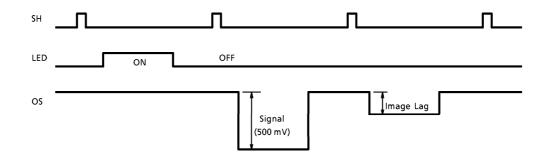
When  $\overline{\chi}$  is average of total signal output and  $\Delta\chi$  is the maximum deviation from  $\overline{\chi}$ . The amount of incident light is shown below.

Red =  $1/2 \cdot SE$ Green =  $1/2 \cdot SE$ 

Bule =  $1/4 \cdot SE$ 

(Note 4) : PRNU (3) is defined as maximum voltage with next pixel, where measured 5% of SE (Typ.).

(Note 5): Image Lag is defined as follows.



(Note 6) : V<sub>SAT</sub> is defined as minimum saturation output of all effective pixels.

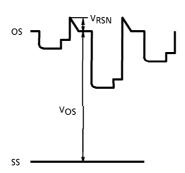
(Note 7) : Definition of SE

$$SE = \frac{V_{SAT}}{R_{G}} (Ix \cdot s)$$

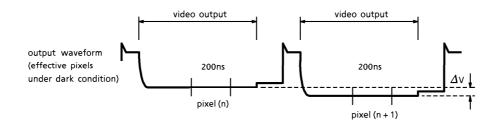
(Note 8) :  $V_{DRK}$  is defined as average dark signal voltage of all effective pixels. DSNU is defined as different voltage between  $V_{DRK}$  and  $V_{MDK}$  when  $V_{MDK}$  is maximum dark signal voltage.



(Note 9) : DC signal output voltage is defined as follows. Reset Noise Voltage is defined as follows.



(Note 10): Random noise is defined as the standard deviation (sigma) of the output level difference between two adjacent effective pixels under no illumination (i.e. dark conditions) calculated by the following procedure.



- 1) Two adjacent pixels (pixel n and n + 1) in one reading are fixed as measurement points.
- 2) Each of the output level at video output periods averaged over 200ns period to get V(n) and V(n + 1).
- 3) V(n + 1) is subtracted from V(n) to get  $\Delta V$ .

$$\Delta V = V(n) - V(n + 1)$$

4) The standard deviation of  $\Delta V$  is calculated after procedure 2) and 3) are repeated 30 times (30 readings).

$$\overline{\Delta V} = \frac{1}{30} \int_{i=1}^{30} |\Delta Vi| \quad \sigma = \sqrt{\frac{1}{30} \int_{i=1}^{30} (|\Delta Vi| - \overline{\Delta V})^2}$$

- 5) Procedure 2), 3) and 4) are repeated 10 times to get sigma value.
- 6) 10 sigma values are averaged.

$$\overline{\sigma} = \frac{1}{10} \int_{j}^{10} \sum_{i=1}^{\infty} \sigma^{ij}$$

7)  $\overline{\sigma}$  value calculated using the above procedure is observed  $\sqrt{2}$  times larger than that measured relative to the ground level. So we specify random noise as follows.

$$ND \sigma = \frac{1}{\sqrt{2}} \overline{\sigma}$$

### **OPERATING CONDITION**

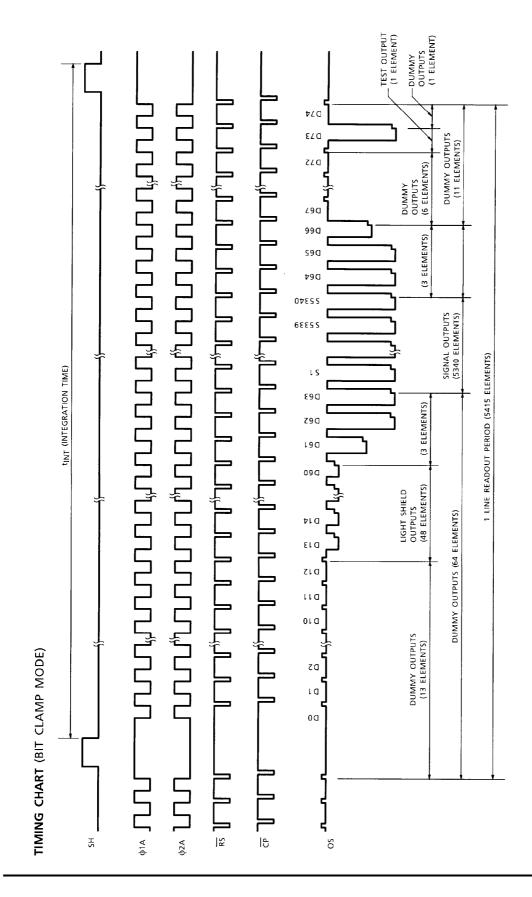
CHARACTERIST	TC TC	SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE
Clock Pulse Voltage	"H" Level	\/ / A	4.5	5.0	5.5	W	
Clock Pulse Voltage	"L" Level	$V\phi A$	0.0	_	0.5	V	
Shift Pulse Voltage	"H" Level	Mari	VφA"H" - 0.5	Vφ <b>Α</b> "H"	V <i>∮</i> A"H"	V	(Noto 11)
Shirt Pulse Voltage	"L" Level	$V_{SH}$	0.0	<del>_</del>	0.5	V	(Note 11)
Reset Pulse Voltage	"H" Level	\/ <del>==</del>	4.5	5.0	5.5	v	
Reset Pulse Voltage	"L" Level	VRS	0.0	_	0.5	] <b>'</b>	
Clamp Pulse Voltage	"H" Level	\/==	4.5	5.0	5.5	V	
Clamp Fulse Voltage	"L" Level	VCP	0.0	_	0.5	] V	
Power Supply Voltage		V <sub>OD</sub>	11.4	12.0	13.0	V	

(Note 11) :  $V\phi A''H''$  means the high level voltage of  $V\phi A$  when SH pulse is high level.

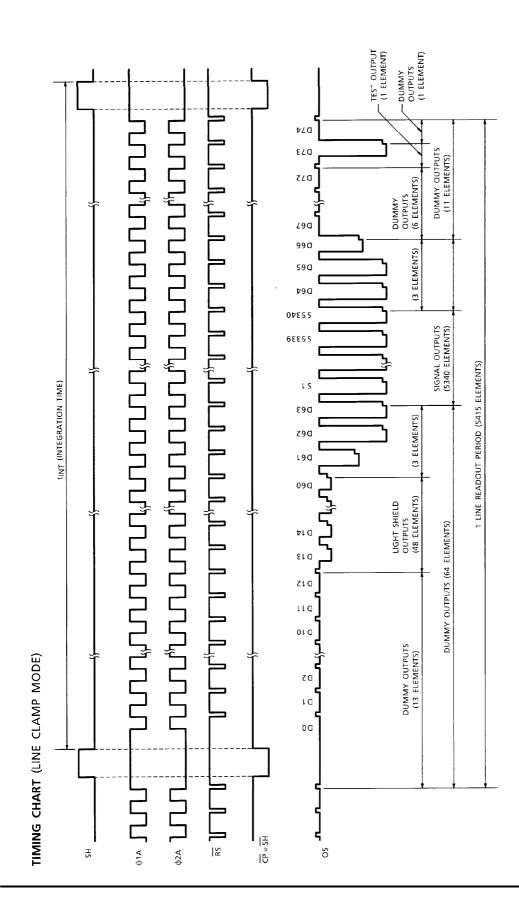
## **CLOCK CHARACTERISTICS** (Ta = 25°C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Clock Pulse Frequency	fφ	0.3	1.0	10	MHz
Reset Pulse Frequency	fRS	0.3	1.0	10	MHz
Clamp Pulse Frequency (Bit clamp mode)	f <del>C</del> P	0.3	1.0	10	MHz
Clock 1 Capacitance (Note 12)	C <i>ϕ</i> 1	_	140	210	pF
Clock 2 Capacitance (Note 12)	C <i>ϕ</i> 2	_	120	180	pF
Shift Gate Capacitance	C <sub>SH</sub>	_	20	60	pF
Reset Gate Capacitance	CRS	_	10	30	pF
Clamp Gate Capacitance	CCP	_	10	30	pF

(Note 12) :  $V_{OD} = 12 V$ 

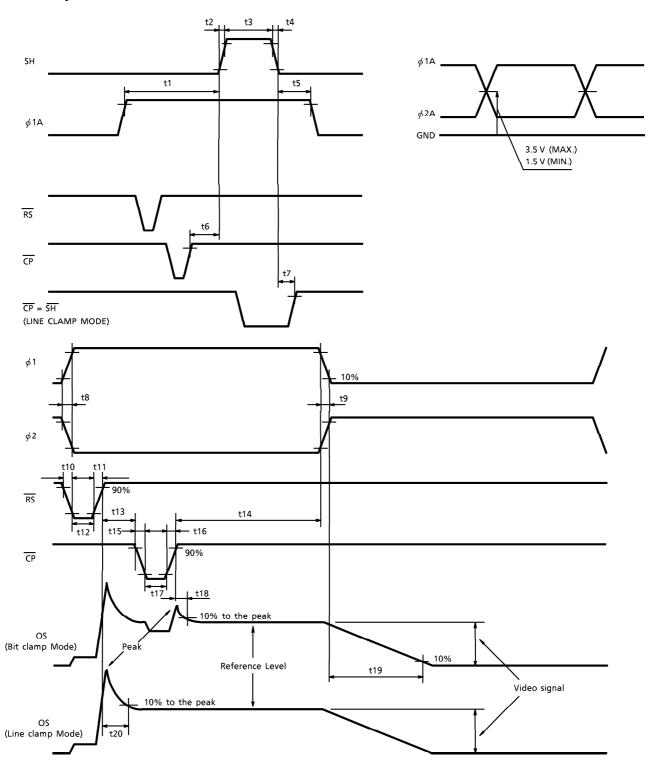


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TCD2558D—8

## TIMING REQUIREMENTS



## TIMING REQUIREMENTS

CHARACTERISTIC	SYMBOL	MIN.	TYP. (Note 13)	MAX.	UNIT
Pulse Timing of SH and $\phi$ 1	t1	120	1000	_	nc
	t5	800	1000	_	ns
SH Pulse Rise Time, Fall Time	t2, t4	0	50	_	ns
SH Pulse Width	t3	3000	5000	_	ns
Pulse Timing of SH and $\overline{CP}$	t6	200	500	_	ns
Pulse Timing of SH and $\overline{\sf CP}$ (Line clamp mode)	t7	10	100	_	ns
$\phi$ 1, $\phi$ 2 Pulse Rise Time, Fall Time	t8, t9	0	50	_	ns
RS Pulse Rise Time, Fall Time	t10, t11	0	20	_	ns
RS Pulse Width	t12	10 (25)	80	_	ns
Pulse Timing of RS and CP	t13	10	20	_	ns
Pulse Timing of $\phi$ 1A, $\phi$ 2A and $\overline{\sf CP}$	t14	0	20	_	ns
CP Pulse Rise Time, Fall Time	t15, t16	0	20	_	ns
CP Pulse Width (Note 14)	t17	25 (3000)	80 (5000)	_	ns
Reference Level Settle Time (Bit clamp mode)	t18	_	20	45 (Note 17)	ns
Video Data Delay Time (Note 15)	t19	_	20	45 (Note 16)	ns
Reference Level Settle Time (Line clamp mode)	t20	_	35	55 (Note 17)	ns

(Note 13) : TYP. is the case of  $f_{\overline{RS}}$  = 1.0 MHz (Note 14) : Line clamp Mode inside ( ).

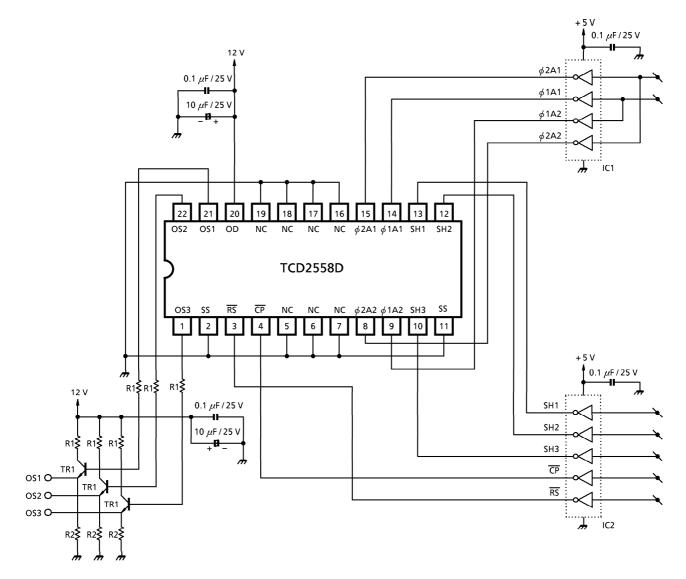
(Note 15) : Load resistance is 100  $\mbox{k}\Omega$ 

(Note 16): Typical settle time to about 1% of final value (Note 17): Typical settle time to about 1% of the peak

## **CLAMP MODE**

CLAMP MEANS	CP INPUT PULSE
Bit Clamp	CP Pulse
Line Clamp	$\overline{CP} = \overline{SH} \text{ or } \overline{CP} = DC 5 V$

### TYPICAL DRIVE CIRCUIT



 $\begin{array}{lll} \text{IC1} & : \text{TC74AC04AP} \\ \text{IC2} & : \text{TC74HC04AP} \\ \text{TR1} & : \text{2SC1815-Y} \\ \text{R1} & : \text{150} \ \Omega \\ \text{R2} & : \text{1500} \ \Omega \\ \end{array}$ 

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#### **CAUTION**

#### 1. Window Glass

The dust and stain on the glass window of the package degrade optical performance of CCD sensor.

Keep the glass window clean by saturating a cotton swab in alcohol and lightly wiping the surface, and allow the glass to dry, by blowing with filtered dry N<sub>2</sub>.

Care should be taken to avoid mechanical or thermal shock because the glass window is easily to damage.

#### 2. Electrostatic Breakdown

Store in shorting clip or in conductive foam to avoid electrostatic breakdown.

## 3. Incident Light

CCD sensor is sensitive to infrared light.

Note that infrared light component degrades resolution and PRNU of CCD sensor.

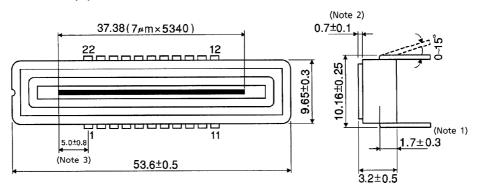
#### 4. Lead Frame Forming

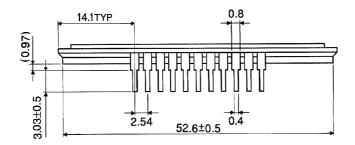
Since this package is not strong against mechanical stress, you should not reform the lead frame. We recommend to use a IC-inserter when you assemble to PCB.

Unit: mm

### **PACKAGE DIMENSIONS**

WDIP22-G-400-2.54D (A)





(Note 1): TOP OF CHIP TO BOTTOM OF PACKAGE.

(Note 2) : GLASS THICKNESS (n = 1.5)

(Note 3): No.1 SENSOR ELEMENT (S1) TO EDGE OF No.1 PIN.

Weight: 5.2 g (Typ.)